

MOSFETs Silicon N-channel MOS (U-MOSIV)

TK100F04K3

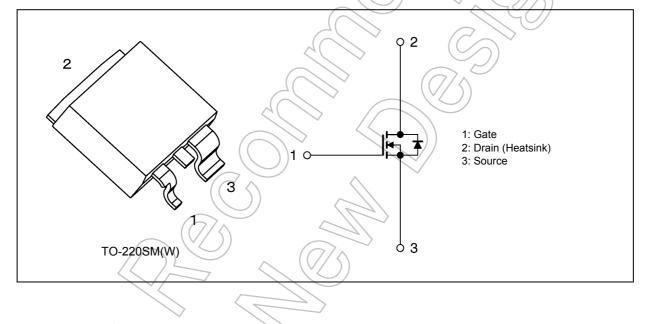
1. Applications

- Switching Voltage Regulators
- · DC-DC Converters
- · Motor Drivers

2. Features

- (1) AEC-Q101 qualified
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 2.5 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (3) High forward transfer admittance: $|Y_{fs}| = 174 \text{ S (typ.)}$
- (4) Low leakage current: I_{DSS} = 10 μA (max) (V_{DS} = 40 V)
- (5) Enhancement mode: $V_{th} = 3.0 \text{ to } 4.0 \text{ V } (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

3. Packaging and Internal Circuit



Start of commercial production

Rev.2.0



4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characte	Symbol	Rating	Unit		
Drain-source voltage			V_{DSS}	40	V
Drain-gate voltage	$(R_{GS} = 20k\Omega)$		V_{DGR}	40	
Gate-source voltage			V _{GSS} (±20	
Drain current (DC)		(Note 1)	I _D	100	Α
Drain current (pulsed)		(Note 1)	I _{DP}	300	
Single-pulse avalanche energy		(Note 2)	E _{AS}	125	mJ
Power dissipation	(T _c = 25°C)		Pp	180	W
Avalanche current		4	Jar)) 100	Α
Repetitive avalanche energy		(Note 3)	E _{AR}	18	mJ
Channel temperature		(Note 4)	T _{ch}	175	°C
Storage temperature		(Note 4)	T _{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

	Characteristics		Symbol	Max	Unit
Channel-to-case thermal resistance		<<))	R _{th(ch-c)}	0.83	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 13 μ H, R_{G} = 25 Ω , I_{AR} = 100 A

Note 3: Repetitive rating; pulse width limited by maximum channel temperature.

Note 4: The definitions of the absolute maximum channel and storage temperatures are qualified per AEC-Q101.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-off current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	7	_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	40	_	_	٧
Drain-source breakdown voltage (Note 5)	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	20) /~	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	3.0	/_	4.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 50 A	$\langle \rangle$	2.5	3.0	mΩ
Forward transfer admittance	Y _{fs}	V _{DS} = 10 V, I _D = 50 A	87	174		S

Note 5: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drain-source breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	7	4500) —	pF
Reverse transfer capacitance	C _{rss}			900	_	
Output capacitance	C _{oss}			1100	_	
Switching time (rise time)	t _r	See Fig. 6.2.1	7-11	21	_	ns
Switching time (turn-on time)	t _{on}		\bigcirc	37	_	
Switching time (fall time)	t _f		リー	31	_	
Switching time (turn-off time)	t _{off}		_	75	_	

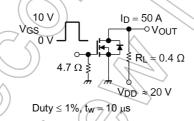


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}$ C unless otherwise specified)

Characteristics	Characteristics Symbol		Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 100 \text{ A}$	_	102	_	nC
Gate-source charge	Q _{gs}		_	56	_	
Gate-drain charge	Q_{gd}		_	46	_	

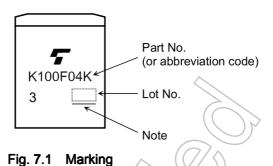
6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 6)	I _{DR}	_	_	_	100	Α
Reverse drain current (pulsed)	(Note 6)	I _{DRP}	_	_	_	300	
Diode forward voltage		V _{DSF}	I _{DR} = 100 A, V _{GS} = 0 V	_	_	-1.2	V
Reverse recovery time		t _{rr}	I _{DR} = 100 A, V _{GS} = 0 V	_	61	_	ns
Reverse recovery charge		Q _{rr}	dl _{DR} /dt = 50 A/μs	_	49	_	nC

Note 6: Ensure that the channel temperature does not exceed 175°C.



7. Marking (Note)



Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.





8. Moisture-Proof Packing

This device is packed in a moisture-proof laminated aluminum bag.

8.1. Precautions for Transportation and Storage (Note)

- (1) Avoid excessive vibration during transportation.
- (2) Do not toss or drop the packed devices to avoid ripping of the bag.
- (3) After opening the moisture-proof bag, the devices should be assembled within two weeks in an environment of 5°C to 30°C and RH70% or below. Perform reflow at most twice.
- (4) The moisture-proof bag may be stored unopened for up to 24 months at 5°C to 30°C and RH90% or below.
- (5) If, upon opening the bag, the moisture indicator card shows humidity of 30% or above (the color of the 30% dot has changed from blue to pink) or the expiration date has passed, the devices should be baked as follows:

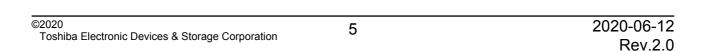
Baking conditions: 125°C for 48 hours.

Note: Since the tape materials are not heat-proof, devices should be placed on either heat-proof trays or aluminum magazines when baking.



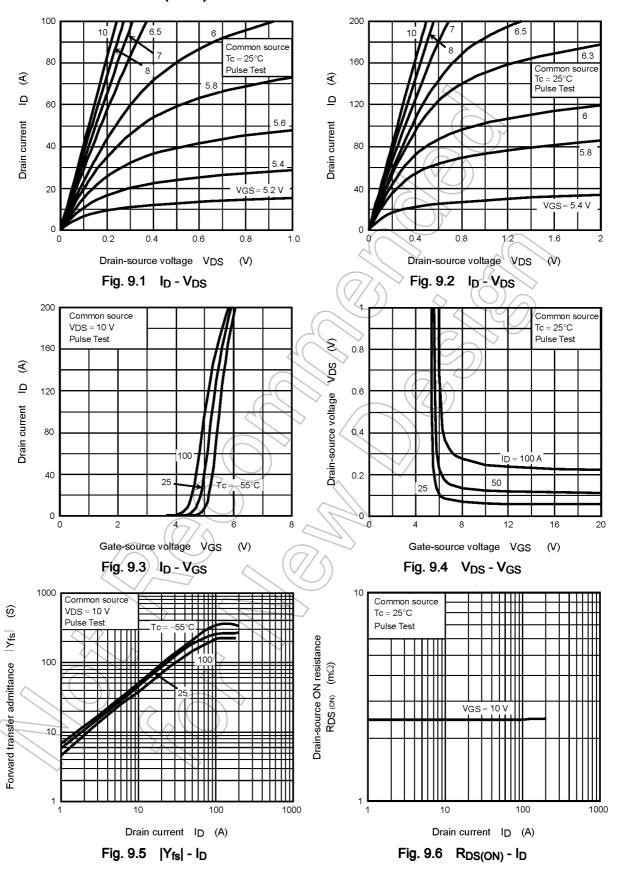
The humidity indicator shows an approximate ambient humidity at $25\,^{\circ}\text{C}$. If the ambient humidity is below $30\,^{\circ}\text{M}$, the color of all the indicator dots is blue. If, upon opening the bag, the color of the $30\,^{\circ}\text{M}$ dot has changed from blue to pink, the devices should be baked before assembly.







9. Characteristics Curves (Note)



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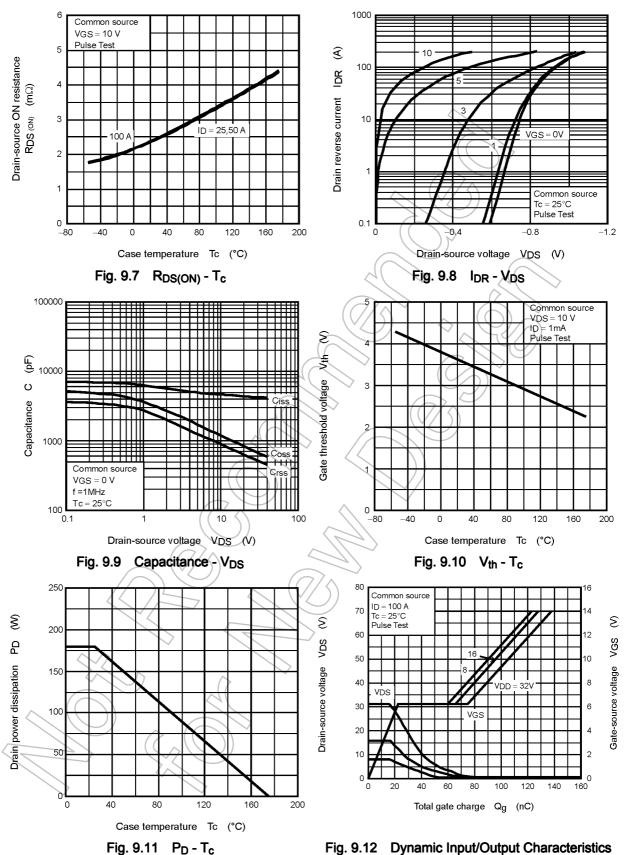


Fig. 9.12 Dynamic Input/Output Characteristics

(Guaranteed Maximum)



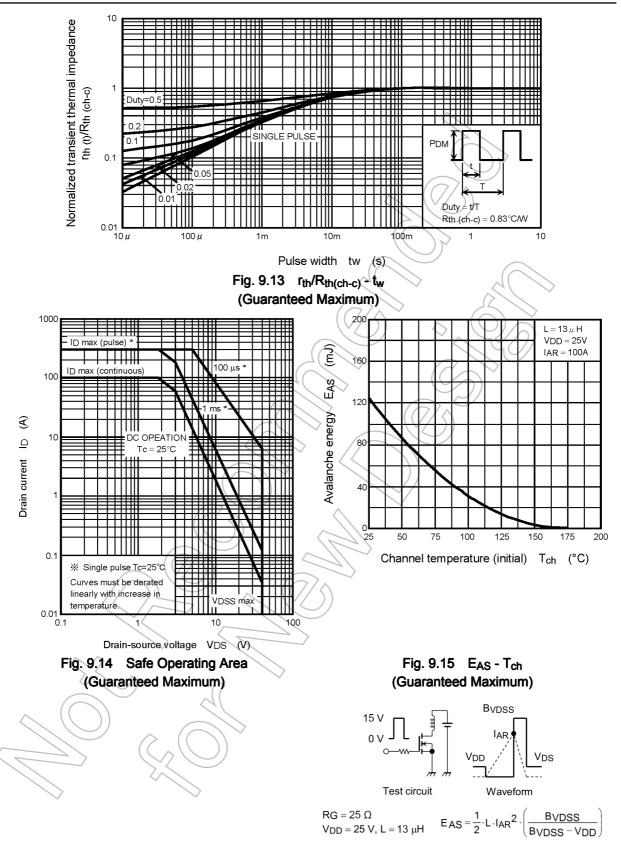


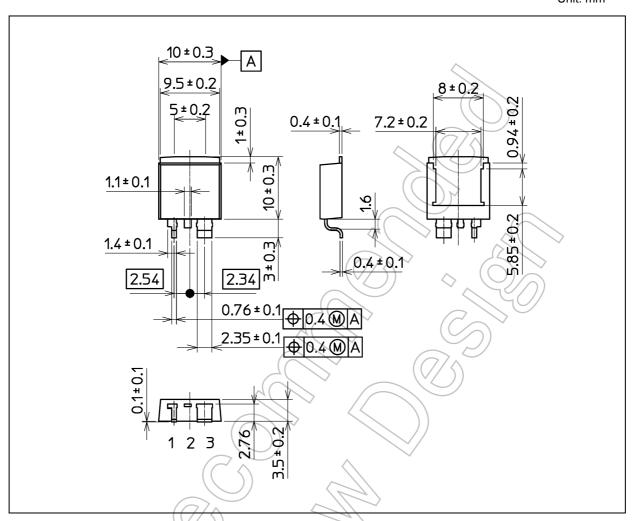
Fig. 9.16 Test Circuit/Waveform

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

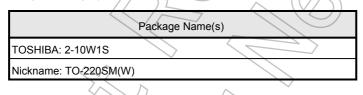


Package Dimensions

Unit: mm



Weight: 1.07 g (typ.)





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